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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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# BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu$ PC813

# J-FET INPUT LOW-OFFSET OPERATIONAL AMPLIFIER

#### **DESCRIPTION**

The  $\mu$ PC813 operational amplifier is a high-speed version of the  $\mu$ PC811. NEC's unique high-speed PNP transistor (fr = 300 MHz) in the output stage yields a high slew rate of 25 V/ $\mu$ s under voltage-follower conditions without an oscillation problem. Zener-zap trimming in the input stage produces excellent offset voltage and temperature drift characteristics.

With AC performance characteristics that are two times better than conventional bi-FET op amps, the  $\mu$ PC813 is ideal for fast integrators, active filters, and other high-speed circuit applications.

#### **FEATURES**

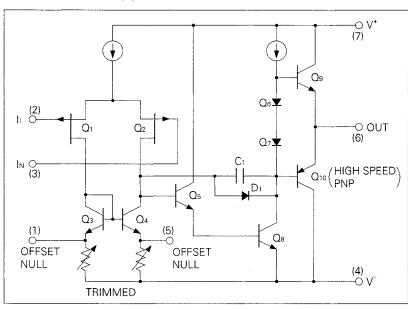
- High slew rate: 25 V/μs (TYP.)
- Stable operation with 220 pF capacitive load
- Low input offset voltage and offset voltage null capability

±2.5 mV (MAX.)

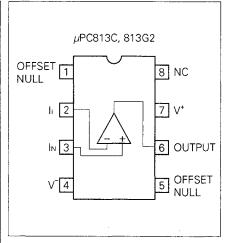
±7 μV/°C (TYP.) temperature drift

- Very low input bias and offset currents
- Low noise :  $e_n = 19 \text{ nV}/\sqrt{\text{Hz}}$  (TYP.)
- Output short circuit protection
- High input impedance ... J-FET Input Stage
- Internal frequency compensation

#### **EQUIVALENT CIRCUIT**



# CONNECTION DIAGRAM (Top View)



#### ORDERING INFORMATION

PART NUMBER	PACKAGE	QUALITY GRADE	
μPC813C	8 PIN PLASTIC DIP (300 mil)	Standard	
μPC813G2	8 PIN PLASTIC SOP (225 mil)	Standard	

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

# ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

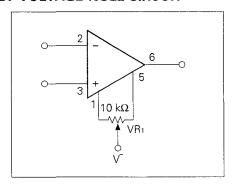
PARAMETER		SYMBOL	μPC813	UNIT
Voltage between V+ and V- (Note1)		te1) V+ ~V-	-0.3 to +36	V
Differential Input Voltage		Vid	±30	V
Input Voltage (Note 2)		e 2) V <sub>I</sub>	V0.3 to V+ +0.3	V
Output Voltage (Note 3)		9 3) Vo	V <sup>-</sup> -0.3 to V <sup>+</sup> +0.3	V
Power Dissipation	C Package (Note	9 4) PT	350	mW
	G2 Package (Note		440	mW
Output Short Circuit Duration (Note 6)		9 6)	Indefinite	sec
Operating Temperature Range		Topt	-40 to +85	°C
Storage Temperature Range		T <sub>stg</sub>	-55 to +125	°C

- Note 1. Reverse connection of supply voltage can cause destruction.
- **Note 2.** The input voltage should be allowed to input without damage or destruction. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The normal operation will establish when the both inputs are within the Common Mode Input Voltage Range of electrical characteristics.
- Note 3. This specification is the voltage which should be allowed to supply to the output terminal from external without damage or destructive. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The output voltage of normal operation will be the Output Voltage Swing of electrical characteristics.
- Note 4. Thermal derating factor is -5.0 mV/°C when ambient temperature is higher than 55 °C.
- Note 5. Thermal derating factor is -4.4 mV/°C when ambient temperature is higher than 25 °C.
- **Note 6.** Pay careful attention to the total power dissipation not to exceed the absolute maximum ratings, Note 4 and Note 5.

#### RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V <sup>±</sup>	±5		±16	V
Output Current	lo			±10	mA
Capacitive Load ( $A_v = +1$ , $R_f = 0 \Omega$ )	Cr			220	pF

#### OFFSET VOLTAGE NULL CIRCUIT



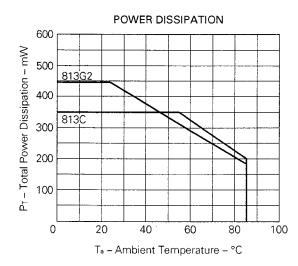
# ELECTRICAL CHARACTERISTICS (T<sub>a</sub> = 25 °C, $V^{\pm}$ = $\pm 15$ V)

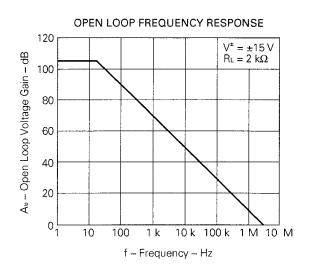
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITION
Input Offset Voltage	Vıo		±1	±2.5	mV	Rs ≦ 50 Ω
Input Offset Current (Note7)	lıo		±25	±100	рА	
Input Bias Current (Note7)	lв		50	200	pА	
Large Signal Voltage Gain	Aυ	25	200		V/mV	$R_L \ge 2 k\Omega$ , $V_0 = \pm 10 V$
Supply Current	lcc		2.5	3.4	mA	lo = 0 A
Common Mode Rejection Ratio	CMR	70	100		dB	
Supply Voltage Rejection Ratio	SVR	70	100		dB	
Output Voltage Swing	Vom	±12	+14.0 -13.3		V	R <sub>L</sub> ≧ 10 kΩ
Output Voltage Swing	Vom	±10	+13.5 -12.8		٧	R∟≧ 2 kΩ
Common Mode Input Voltage Range	Vicм	±11	+14 12		V	
Slew Rate	SR		25		V/μs	A <sub>υ</sub> = 1
Unity Gain Frequency	funity		6		MHz	
Input Equivalent Noise Voltage Density	<b>e</b> n		19		nV/√Hz	Rs = 100 Ω, f = 1 kHz
Input Offset Voltage	<b>V</b> 10			±5	mV	Rs $\leq$ 50 $\Omega$ , Ta = -20 to +70 °C
Average Vio Temperature Drift	⊿Vio/⊿T		±7		μV/°C	Ta = -20 to +70 °C
Input Offset Current (Note7)	lıo			±2	nA	Ta = -20 to +70 °C
Input Bias Current (Note7)	la			7	nA	T <sub>a</sub> = -20 to +70 °C

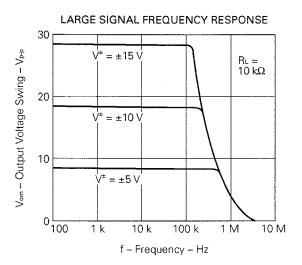
Note 7. Input bias currents flow into IC. Because each currents are gate leak current of P-channel J-FET on input stage.

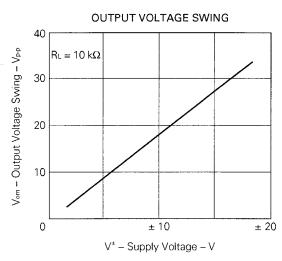
And that are temperature sensitive. Short time measuring method is recommendable to maintain the junction temperature close to the ambient temperature.

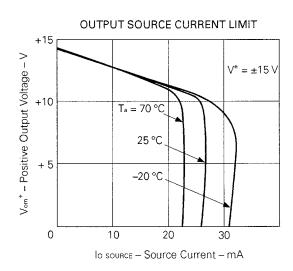
# TYPICAL PERFORMANCE CHARACTERISTICS (Ta = 25 °C, TYP.)

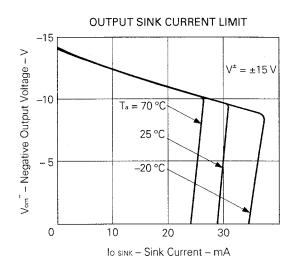




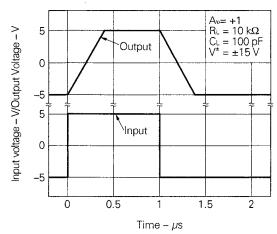




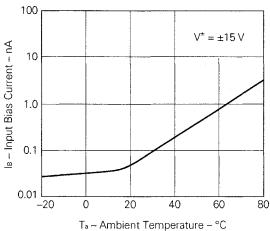




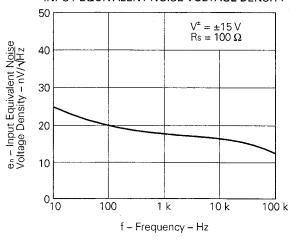




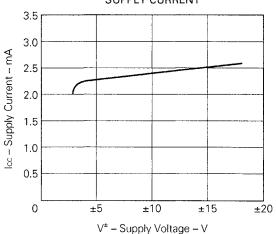
#### INPUT BIAS CURRENT



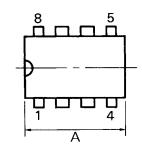
#### INPUT EQUIVALENT NOISE VOLTAGE DENSITY

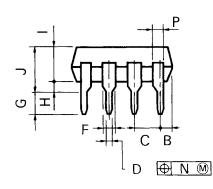


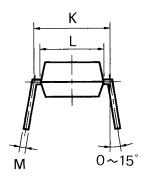
#### SUPPLY CURRENT



# 8PIN PLASTIC DIP (300 mil)







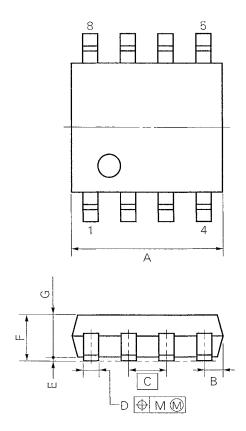
P8C-100-300B,C

# **NOTES**

- Each lead centerline is located within 0.25 mm (0.01 inch) of its true position (T.P.) at maximum material condition.
- 2) Item "K" to center of leads when formed parallel.

ITEM	MILLIMETERS	INCHES
Α	10.16 MAX.	0.400 MAX.
В	1.27 MAX.	0.050 MAX.
С	2.54 (T.P.)	0.100 (T.P.)
D	0.50 <sup>±0.10</sup>	0.020 +0.004
F	1.4 MIN.	0.055 MIN.
G	3.2 ±0.3	0.126 ±0.012
Н	0.51 MIN.	0.020 MIN.
1	4.31 MAX.	0.170 MAX.
J	5.08 MAX.	0.200 MAX.
K	7.62 (T.P.)	0.300 (T.P.)
L	6.4	0.252
М	0.25 -0.05	0.010 -0.004
N	0.25	0.01
Р	0.9 MIN.	0.035 MIN.

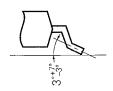
# 8 PIN PLASTIC SOP (225 mil)

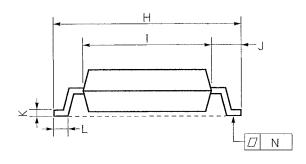


# NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

detail of lead end





S8GM-50-225B-2

ITEM	MILLIMETERS	INCHES
А	5.37 MAX.	0.212 MAX.
В	0.78 MAX.	0.031 MAX.
С	1.27 (T.P.)	0.050 (T.P.)
D	0.40+0.10	0.016+0.004
E	0.1±0.1	0.004±0.004
F	1.8 MAX. 0.071MA	
G	1.49	0.059
Н	6.5±0.3	0.256±0.012
	4.4 0.173	
J	1.1	0.043
К	0.15+0.10	0.006+0.004
L	0.6±0.2	0.024+0.008
М	0.12	0.005
N	0.15	0.006



#### RECOMMENDED SOLDERING CONDITIONS

The following conditions (see table below) must be met when soldering this product.

Please consult with our sales offices in case other soldering process is used, or in case soldering is done under different conditions.

#### **TYPES OF SURFACE MOUNT DEVICE**

For more details, refer to our document "SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL" (IEI-1207).

# [ $\mu$ PC813G2 ]

Soldering method	Soldering conditions	Recommended condition symbol
Infrared ray reflow	Peak package's surface temperature: 230 °C or below, Reflow time: 30 seconds or below (210 °C or higher), Number of reflow process: 1, Exposure limit*: None	IR30-00-1
VPS	Peak package's surface temperature: 215 °C or below, Reflow time: 40 seconds or below (200 °C or higher), Number of reflow process: 1, Exposure limit*: None	VP15-00-1
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or below, Number of flow process: 1, Exposure limit*: None	WS15-00-1
Partial heating method	Terminal temperature: 300 °C or below, Flow time: 10 seconds or below, Exposure limit*: None	

<sup>\*:</sup> Exposure limit before soldering after dry-pack package is opened. Storage conditions: 25 °C and relative humidity at 65 % or less.

Note: Do not apply more than a single process at once, except for "Partial heating method."

#### TYPES OF THROUGH HOLE DEVICE

# [µPC813C]

Soldering method	Soldering conditions	Recommended condition symbol
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or below	

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